

**PRELIMINARY**

Notice: This is not a final specification.  
Some parametric limits are subject to change.

MITSUBISHI SEMICONDUCTOR (GaAs FET)

# MGFC36V5964A

5.9~6.4GHz BAND 4W INTERNALLY MATCHED GaAs FET

## DESCRIPTION

The MGFC36V5964A is an internally impedance-matched GaAs power FET especially designed for use in 5.9~6.4GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

## FEATURES

- Class A operation
- Internally matched to 50Ω system
- High output power  
 $P_{1dB} = 4W(TYP) @ 5.9\sim 6.4GHz$
- High power gain  
 $GLP = 10dB(TYP) @ 5.9\sim 6.4GHz$
- High power added efficiency  
 $\eta_{add} = 30\%(TYP) @ 5.9\sim 6.4GHz$
- Hermetically sealed metal-ceramic package
- Low distortion [Item : - 51]  
 $IM_3 = -45dBc(TYP) @ P_o = 25(dBm) S.C.L.$

## APPLICATION

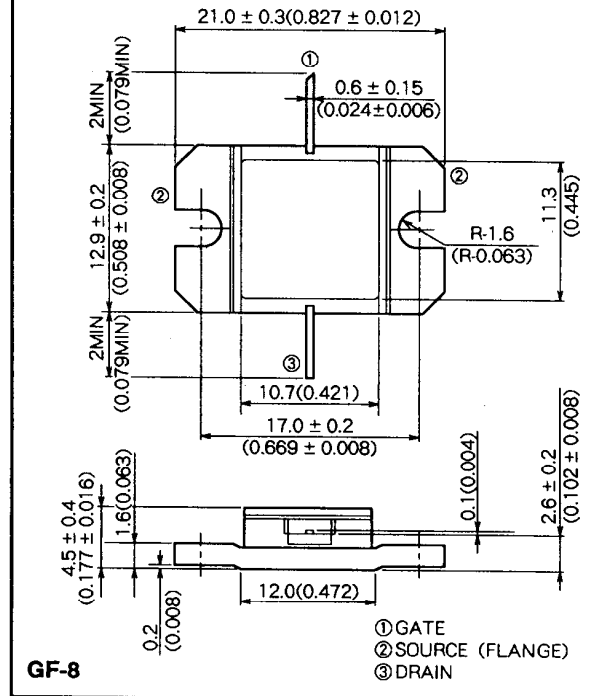
- Item-01 : 5.9~6.4GHz band power amplifier
- Item-51 : Digital radio communication

## QUALITY GRADE

- IG

## OUTLINE DRAWING

Unit : millimeters (inches)



GF-8

- ① GATE
- ② SOURCE (FLANGE)
- ③ DRAIN

## RECOMMENDED BIAS CONDITIONS

- $V_{DS} = 10V$
- $I_D = 1.2A$
- $R_G = 100(\Omega)$
- Refer to Bias Procedure

## ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Symbol	Parameter	Ratings	Unit
$V_{GDO}$	Gate to drain voltage	- 15	V
$V_{GSO}$	Gate to source voltage	- 15	V
$I_D$	Drain current	3.75	A
$I_{GR}$	Reverse gate current	- 10	mA
$I_{GF}$	Forward gate current	21	mA
$P_T$	Total power dissipation * 1	25	W
$T_{ch}$	Channel temperature	175	°C
$T_{stg}$	Storage temperature	- 65 ~ + 175	°C

\* 1 :  $T_c = 25^\circ C$

## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$I_{DSS}$	Saturated drain current	$V_{DS} = 3V, V_{GS} = 0V$	-	-	3.75	A
$g_m$	Transconductance	$V_{DS} = 3V, I_D = 1.1A$	-	1	-	S
$V_{GS(off)}$	Gate to source cut-off voltage	$V_{DS} = 3V, I_D = 10mA$	-	-	- 4.5	V
$P_{1dB}$	Output power at 1dB gain compression	$V_{DS} = 10V, I_D = 1.2A, f = 5.9\sim 6.4GHz$	35	36	-	dBm
$GLP$	Linear power gain		9	10	-	dB
$I_D$	Drain current		-	-	1.8	A
$\eta_{add}$	Power added efficiency		-	30	-	%
$IM_3$	3rd order IM distortion * 1		- 42	- 45	-	dBc
$R_{th(ch-c)}$	Thermal resistance * 2		$\Delta V_f$ method	-	5	6

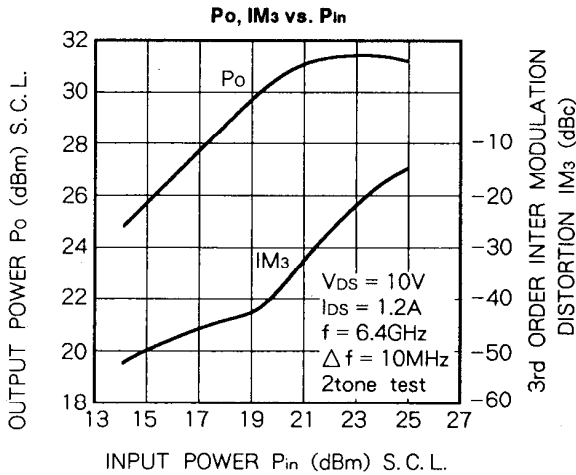
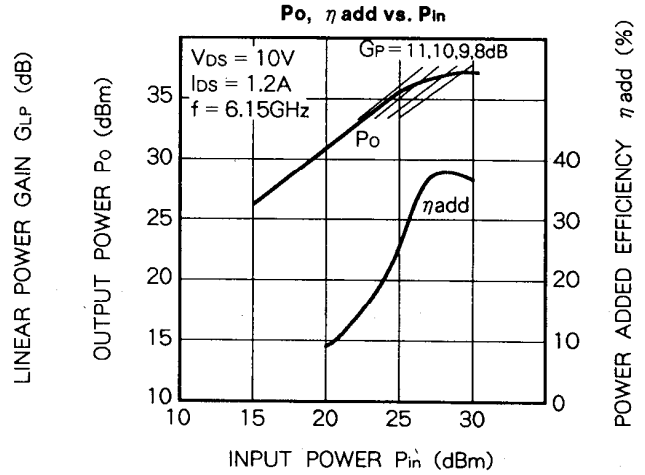
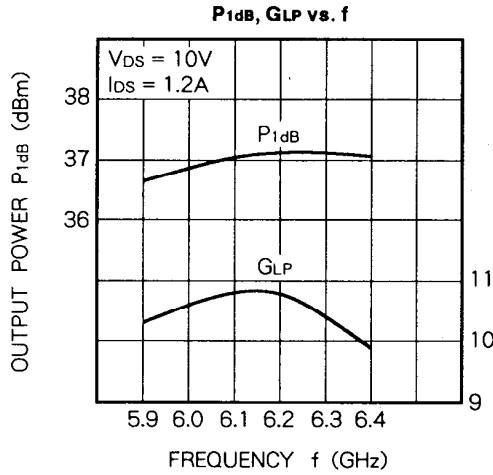
\* 1 : Item-51, 2-tone test  $P_o = 25dBm$  Single Carrier Level  $f = 6.4GHz$   $\Delta f = 10MHz$  \* 2 : Channel to case

NOV. '97

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TYPICAL CHARACTERISTICS



S PARAMETERS (T<sub>a</sub> = 25°C, V<sub>DS</sub> = 10V, I<sub>DS</sub> = 1.2A)

f (GHz)	S parameters							
	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)
5.9	0.22	-171	3.29	-27	0.079	-70	0.47	-172
6.0	0.12	145	3.40	-44	0.081	-89	0.41	178
6.1	0.12	60	3.49	-59	0.082	-104	0.34	166
6.2	0.23	20	3.49	-75	0.084	-120	0.27	153
6.3	0.35	-1	3.32	-91	0.081	-135	0.19	139
6.4	0.44	-16	3.08	-106	0.079	-149	0.13	124